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This standard includes the English version of the European Standard.

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Réseaux de communication industriels - Spécifications des bus de terrain - Partie 4-19: Spécification du protocole de la couche liaison de données - Eléments de type 19 (CEI 61158-4-19:2014)

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The text of document 65C/762/FDIS, future edition 3 of IEC 61158-4-19, prepared by SC 65C “Industrial networks” of IEC/TC 65 “Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 61158-4-19:2014.

The following dates are fixed:

• latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement	(dop)	2015-06-19
• latest date by which the national standards conflicting with the document have to be withdrawn	(dow)	2017-09-19

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IEC 61131 Series	NOTE	Harmonised as EN 61131 Series
IEC 61158-1:2014	NOTE	Harmonised as EN 61158-1:2014
IEC 61158-3-19:2014	NOTE	Harmonised as EN 61158-3-19:2014
IEC 61158-5-16:2007	NOTE	Harmonised as EN 61158-5-16:2007
IEC 61158-5-19:2014	NOTE	Harmonised as EN 61158-5-19:2014
IEC 61158-6-16:2007	NOTE	Harmonised as EN 61158-6-16:2007
IEC 61158-6-19:2014	NOTE	Harmonised as EN 61158-6-19:2014
IEC 61784-1	NOTE	Harmonised as EN 61784-1
IEC 61784-2	NOTE	Harmonised as EN 61784-2
IEC 61800-7 Series	NOTE	Harmonised as EN 61800-7 Series
IEC 61800-7-201	NOTE	Harmonised as EN 61800-7-201
IEC 61800-7-202	NOTE	Harmonised as EN 61800-7-202
IEC 61800-7-203	NOTE	Harmonised as EN 61800-7-203
IEC 61800-7-204	NOTE	Harmonised as EN 61800-7-204

Annex ZA
(normative)

Normative references to international publications with their corresponding European publications

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 When an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

Publication	Year	Title	EN/HD	Year
IEC 61158-4-16	2007	Industrial communication networks - Fieldbus specifications Part 4-16: Data-link layer protocol specification - Type 16 elements	EN 61158-4-16	2008
ISO/IEC 7498-1	-	Information technology - Open Systems Interconnection - Basic reference model: The basic model	-	-
ISO/IEC 7498-3	-	Information technology - Open Systems Interconnection - Basic reference model: Naming and addressing	-	-
ISO 8601	-	Data elements and interchange formats - Information interchange - Representation of dates and times	-	-
ISO/IEC 8802-3	-	Information technology - Telecommunications and information exchange between systems - Local and metropolitan area networks - Specific requirements Part 3: Carrier sense multiple access with collision detection (CSMA/CD) access method and physical layer specifications	-	-
IEEE 802.3	-	IEEE Standard for Information technology - Telecommunications and information exchange between systems - Local and metropolitan area networks - Specific requirements Part 3: Carrier Sense Multiple Access with Collision Detection (CSMA/CD) Access Method and Physical Layer Specifications	-	-
IETF RFC 879	-	The TCP Maximum Segment Size and Related Topics	-	-

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

INDUSTRIAL COMMUNICATION NETWORKS – FIELDBUS SPECIFICATIONS –

Part 4-19: Data-link layer protocol specification – Type 19 elements

FOREWORD

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Attention is drawn to the fact that the use of the associated protocol type is restricted by its intellectual-property-right holders. In all cases, the commitment to limited release of intellectual-property-rights made by the holders of those rights permits a layer protocol type to be used with other layer protocols of the same type, or in other type combinations explicitly authorized by its intellectual-property-right holders.

NOTE Combinations of protocol types are specified in IEC 61784-1 and IEC 61784-2.

International Standard IEC 61158-4-19 has been prepared by subcommittee 65C: Industrial networks, of IEC technical committee 65: Industrial-process measurement, control and automation.

This third edition cancels and replaces the second edition published in 2010. This edition constitutes a technical revision. The main changes with respect to the previous edition are listed below:

- introducing connections based on a producer-consumer model;

- introducing additional mechanisms to realize features such as timestamping and oversampling;
- improving the hotplug and redundancy features;
- improving the phase switching and the error handling;
- editorial improvements.

The text of this standard is based on the following documents:

FDIS	Report on voting
65C/762/FDIS	65C/772/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all the parts of the IEC 61158 series, under the general title *Industrial communication networks – Fieldbus specifications*, can be found on the IEC web site.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

IMPORTANT – The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

INTRODUCTION

This part of IEC 61158 is one of a series produced to facilitate the interconnection of automation system components. It is related to other standards in the set as defined by the “three-layer” fieldbus reference model described in IEC 61158-1.

The data-link protocol provides the data-link service by making use of the services available from the physical layer. The primary aim of this standard is to provide a set of rules for communication expressed in terms of the procedures to be carried out by peer data-link entities (DLEs) at the time of communication. These rules for communication are intended to provide a sound basis for development in order to serve a variety of purposes:

a) as a guide for implementors and designers;

b) for use in the testing and procurement of equipment;

c) as part of an agreement for the admittance of systems into the open systems environment;

d) as a refinement to the understanding of time-critical communications within OSI.

This standard is concerned, in particular, with the communication and interworking of sensors, effectors and other automation devices. By using this standard together with other standards positioned within the OSI or fieldbus reference models, otherwise incompatible systems may work together in any combination.

NOTE Attention is drawn to the fact that use of the associated protocol type(s) is restricted by its (their) intellectual-property-right holder(s). In all cases, the commitment to limited release of intellectual-property-rights made by the holder(s) of those rights permits a particular data-link layer protocol type to be used with physical layer and application layer protocols in Type combinations as specified explicitly in the profile parts. Use of the various protocol type(s) in other combinations may require permission from their respective intellectual-property-right holders.

The International Electrotechnical Commission (IEC) draws attention to the fact that it is claimed that compliance with this document may involve the use of patents concerning Type 19 elements and possibly other types given in this document as follows:

DE 102 00 502 4759.8-32	[BR]	Verfahren zur Laufzeitkorrektur in einer Kommunikationsstruktur
DE 102 37 097	[RI]	Korrektur von Signallaufzeiten in verteilten Kommunikationssystemen

IEC takes no position concerning the evidence, validity and scope of these patent rights.

The holders of these patent rights have assured IEC that they are willing to negotiate licenses either free of charge or under reasonable and non-discriminatory terms and conditions with applicants throughout the world. In this respect, the statement of the holders of these patent rights is registered with IEC. Information may be obtained from:

[BR] BoschRexrothAG
Zum Eisengiesser 1
D-97816 Lohr
Germany

[RI] Rexroth Indramat GmbH
Bgm.-Dr.-Nebel-Str. 2
D - 97816 Lohr
Germany

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INDUSTRIAL COMMUNICATION NETWORKS – FIELDBUS SPECIFICATIONS –

Part 4-19: Data-link layer protocol specification – Type 19 elements

1 Scope

1.1 General

The data-link layer provides basic time-critical messaging communications between devices in an automation environment.

This protocol provides communication opportunities to all participating data-link entities

a) in a synchronously-starting cyclic manner, according to a pre-established schedule, and

b) in a cyclic or acyclic asynchronous manner, as requested each cycle by each of those data-link entities.

Thus this protocol can be characterized as one which provides cyclic and acyclic access asynchronously but with a synchronous restart of each cycle.

1.2 Specifications

This standard specifies

a) procedures for the timely transfer of data and control information from one data-link user entity to a peer user entity, and among the data-link entities forming the distributed data-link service provider;

b) the structure of the fieldbus DLPDUs used for the transfer of data and control information by the protocol of this standard, and their representation as physical interface data units.

1.3 Procedures

The procedures are defined in terms of

a) the interactions between peer DL-entities (DLEs) through the exchange of fieldbus DLPDUs;

b) the interactions between a DL-service (DLS) provider and a DLS-user in the same system through the exchange of DLS primitives;

c) the interactions between a DLS-provider and a Ph-service provider in the same system through the exchange of Ph-service primitives.

1.4 Applicability

These procedures are applicable to instances of communication between systems which support time-critical communications services within the data-link layer of the OSI or fieldbus reference models, and which require the ability to interconnect in an open systems interconnection environment.

Profiles provide a simple multi-attribute means of summarizing an implementation’s capabilities, and thus its applicability to various time-critical communications needs.

1.5 Conformance

This standard also specifies conformance requirements for systems implementing these procedures. This part of this standard does not contain tests to demonstrate compliance with such requirements.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE All parts of the IEC 61158 series, as well as IEC 61784-1 and IEC 61784-2 are maintained simultaneously. Cross-references to these documents within the text therefore refer to the editions as dated in this list of normative references.

IEC 61158-4-16:2007, *Industrial communication networks – Fieldbus specifications – Part 4-16: Data-link layer protocol specification – Type 16 elements*

ISO/IEC 7498-1, *Information technology – Open Systems Interconnection – Part 1: Basic Reference Model: The Basic Model*

ISO/IEC 7498-3, *Information technology – Open Systems Interconnection – Part 3: Basic Reference Model: Naming and addressing*

ISO/IEC 8802-3, *Information technology – Telecommunications and information exchange between systems – Local and metropolitan area networks – Specific requirements – Part 3: Carrier sense multiple access with collision detection (CSMA/CD) access method and physical layer specifications*

ISO 8601, *Data elements and interchange formats – Information interchange – Representation of dates and times*

IEEE 802.3: *IEEE Standard for Information technology – Telecommunications and information exchange between systems – Local and metropolitan area networks – Specific requirements – Part 3: Carrier Sense Multiple Access with Collision Detection (CSMA/CD) Access Method and Physical Layer Specifications*

Internet Engineering Task Force (IETF), *Request for Comments (RFC): RFC 879, The TCP Maximum Segment Size and Related Topics* (available at <http://www.ietf.org/rfc/rfc0879.txt>)

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